



AMENDMENT TRANSMITTAL LETTER					Docket No. 0649-1005PUS1
Application No.		Filing Date		Examiner	Art Unit
10/815,754-Conf. #9965		April 2, 2004		D. J. Brown	3616
Applicant(s): Mas	Sao TAKESHIN	IA et al.		·	
nvention: FRAME		E IN SADDLE	TYPE VEHIC	LE AND METHOD (	OF MANUFACTURING
MS Amendment Commissioner for I P.O. Box 1450 Alexandria, VA 223 Transmitted here	313-1450	ndment in the	ahove-identif	ied application	
The fee has been				• •	
		CLAIM	S AS AMENI	DED	
	Claims Remaining After Amendment	Highest Number Previously Pald	Number Extra Claims Present	Rate	
Total Claims	20	- 20 =	0	x 50.00	0.00
Independent Claims	5	- 5 =	0	x 200.00	0.00
Multiple Depend	lent Claims (ch	eck if applicabl	e)		
Other fee (pleas	e specify):				
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT: 0.00					
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x No additiona		d for this amer	ndment.		
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Janes /	<u> </u>	ithu		Dated:	May 7, 2007
James M. Slatte Attorney Reg. N			)		
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(PATENT)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Masao TAKESHIMA et al.

Application No.: 10/815,754

Filed: April 2, 2004

For: FRAME STRUCTURE IN SADDLE TYPE

VEHICLE AND METHOD OF MANUFACTURING FRAME

Confirmation No.: 9965

Art Unit: 3616

Examiner: D.J. Brown

## **REQUEST FOR RECONSIDERATION**

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

## **INTRODUCTORY COMMENTS**

In response to the Examiner's Office Action dated February 9, 2007, the following remarks are respectfully submitted in connection with the above-identified U.S. patent application.

This reply includes:

Remarks.